

SN54279, SN54LS279A, SN74279, SN74LS279A QUADRUPLE S-R LATCHES

SDLS093 - DECEMBER 1983 - REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs

- Dependable Texas Instruments Quality and Reliability

description

The '279 offers 4 basic \bar{S} - \bar{R} flip-flop latches in one 16-pin, 300-mil package. Under conventional operation, the \bar{S} - \bar{R} inputs are normally held high. When the \bar{S} input is pulsed low, the Q output will be set high. When \bar{R} is pulsed low, the Q output will be reset low. Normally, the \bar{S} - \bar{R} inputs should not be taken low simultaneously. The Q output will be unpredictable in this condition.

FUNCTION TABLE
(each latch)

INPUTS		OUTPUT
\bar{S}^\dagger	\bar{R}	Q
H	H	Q_0
L	H	H
H	L	L
L	L	H^\ddagger

H = high level L = low level

† For latches with double S inputs:

Q_0 = the level of Q before the indicated input conditions were established.

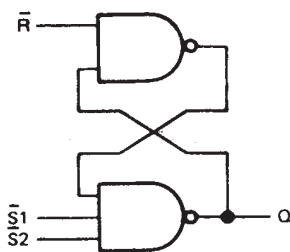
‡ This configuration is nonstable: that is, it may not persist when the \bar{S} and \bar{R} inputs return to their inactive (high) level.

H = both \bar{S} inputs high

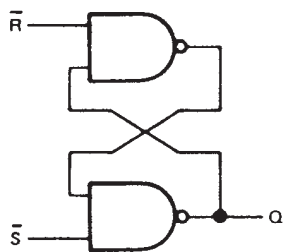
L = one or both \bar{S} inputs low

logic diagram (positive logic)

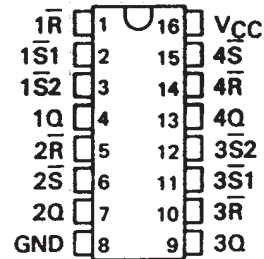
(latches 1 and 3)



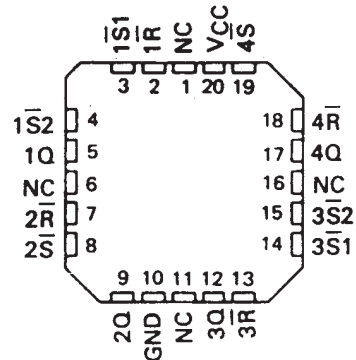
(latches 2 and 4)



SN54279, SN54LS279A . . . J OR W PACKAGE
SN74279 . . . N PACKAGE
SN74LS279A . . . D OR N PACKAGE
(TOP VIEW)

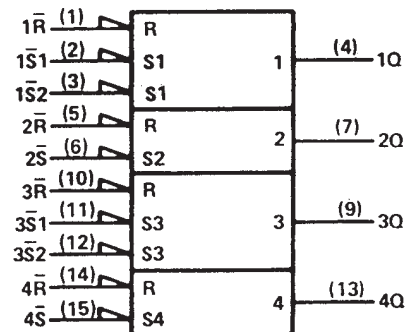


SN54LS279A . . . FK PACKAGE
(TOP VIEW)



NC - No internal connection

logic symbol[§]



[§]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
76018012A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
7601801EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
7601801EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
7601801FA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
7601801FA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SN54279J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN54279J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN54LS279AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN54LS279AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN74279N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74279N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74279N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74279N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS279AD	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS279AD	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS279ADE4	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS279ADE4	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS279ADR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS279ADR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS279ADRE4	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS279ADRE4	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS279AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS279AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS279AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS279AN3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS279ANSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS279ANSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS279ANSRE4	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS279ANSRE4	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SNJ54279J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SNJ54279J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SNJ54279W	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SNJ54279W	OBSOLETE	CFP	W	16		TBD	Call TI	Call TI
SNJ54LS279AFK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS279AFK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS279AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS279AJ	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS279AW	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS279AW	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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